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TITLE				
RotaConnect™		1 of 8 AUTHORIZED BY	DATE	
		Mathew Jacob	27 JAN 2025	

1.0 Objective

This specification defines the performance, test, quality and reliability requirements of the Rotatable Board to Board connector (RotaConnect[™]).

2.0 Scope

This specification is applicable to the termination characteristics of the RotaConnect[™] family of products which provides perpendicular, co-planar, or angled interconnect solutions. The hermaphroditic board-toboard connector, which mates to itself, can also be placed anywhere on the PCB, further expanding design options.

Featuring a 3mm pitch, these high powered board to board connectors are available in positions ranging from 2 up to 14 (in increments of two).

Applications include control boards, sensors, actuators, rigid LED strips and automotive electronics.

3.0 Ratings

3.1 Operating Voltage Rating = 125V AC

3.2Current Rating per contact – 5.0 Amps DC, for total connector see below table

Table 1.1

NO OF POSITION	2 POS	4 POS	6 POS
CURRENT RATING IN AMPS	5	4	3.5

Note: Connectors are applied to test boards with 1 layers X 3 ounce copper power plane.

3.3 Operating Temperature Range = -40°C to 125 °C

4.0 Applicable Documents

- 4.1 FCI Engineering drawings: 10120045-200C, 10120045-400C, 10120045-600
- 4.2 EIA 364: Electrical Connector/Socket Test Procedures Including Environmental Classifications.
- 4.3 GS-20-0379: Application Specification.

5.0 Requirements

5.1 Qualification

Connectors furnished under this specification shall be capable of meeting the qualification test requirements specified herein.

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5.2 Material

Plug/Receptacle Terminal & Bracket: Copper alloy

Housing: High temperature thermoplastic

5.3 Finish

Contact plating: Au + PdNi over Ni for active zone, Sn (matte) over Ni for terminal zone.

Bracket plating: Sn (matte) over Ni

5.4 Design and Construction

Connectors shall be of the design, construction, and physical dimensions specified on the applicable product drawing. There shall be no cracks, burrs, or other physical defects that may impair performance.

A Rotatable board to board SMT connector that can be used to support perpendicular, coplanar and angled connections, in multiple mating/un-mating directions.

The hermaphroditic 'mates to itself' design enables mating at any angle between $+90^{\circ}$ and -60° which enables connector to be placed anywhere on the PCB.

This design allows the uses of a single part number which will compromise both male and female contacts. The high temperature grade housing material is reflow soldering compatible. The tape and reel packaging permits vacuum pick and place application.

Features and Benefits:

- 1. Connector mates to itself (hermaphroditic)
- 2. Reliable dual beam contact.
- 3. Hold down for PCB retention
- 4. Pins are protected by housing
- 5. Floating and rotation possible
- 6. Supports multiple mating and un-mating directions
- 7. High temperature material for reflow process
- 8. RoHS Compliant

6.0 General

6.1 Visual

Visual examinations shall be performed with a magnification up to 10X (8 to 10X recommended). Parts should be free from blistering, cracks, discoloration, etc.

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6.2 Banned/Restricted Substances

All products where the part number ends in 'LF' meet the European Union directives and other country regulations as described in GS-22-008. The part numbers that do not end in 'LF' meet all regulations except for Pb in SnPb plating.

7.0 Electrical Characteristics

7.1 Low Level Contact Resistance (LLCR)

The LLCR shall not exceed 18 milliohms initially. The LLCR shall also not exceed 5 milliohms increase in resistance (from the initial measurement) after any treatment and/or environmental exposure. Measurements shall be in accordance with EIA-364-23.

The following details shall apply:

- a. Test Voltage 20 milli-volts DC max open circuit.
- b. Test Current Not to exceed 100 milli-amperes.

7.2 Insulation Resistance

The insulation resistance of unmated connectors shall not be less than 1 mega ohms after environmental exposure when measured in accordance with EIA-364-21.

The following details shall apply:

- a. Test Voltage 500 volts DC.
- b. Electrification Time 2 minutes, unless otherwise specified.
- c. Points of Measurement Between adjacent contacts of unmated specimens

7.3 Dielectric Withstanding Voltage

There shall be no evidence of arc-over, insulation breakdown, when unmated connectors are tested in accordance with EIA-364-20, Condition 1.

The following details shall apply:

- a. Test Voltage 1500 volts AC at sea level
- b. Test Duration 60 seconds.
- c. Test Condition 1 atm
- d. Points of Measurement Between adjacent contacts of unmated specimens

7.4 Current Rating

The temperature rise above ambient shall not exceed 30 deg C at any point in the system when all contacts are powered- *refer table 1.1 for current rating for corresponding Position*

The following details shall apply:

- a. Ambient Conditions Still air at 25 °C
- b. Reference EIA-364-70, Method 1

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8.0 Mechanical Characteristics

8.1 Mating/Unmating Force

The force necessary to mate and unmate specimens is as shown in the below table.

The following details shall apply:

- a. Cross Head Speed 25.4 mm per minute.
- b. Lubrication none.
- c. Utilize free floating fixtures.
- d. Reference EIA-364-13

Position	Mating Force (N) Maximum	Unmating Force (N) Minimum
2	10	2.5
4	20	5
6	30	7.5

8.2 Durability

The connector pairs shall be capable of withstanding \leq 10 mating/unmating cycles at a maximum rate of 25.4 mm per minute. Reference EIA-364-09.

8.3 Resistance to reflow soldering heat

The housing will withstand exposure to 260°C peak temperature for 10 seconds in convection, infrared or vapor phase reflow oven. Housing shall be free of deformation and fusion.

9.0 Environmental Conditions

After exposure to the following environmental conditions in accordance with the specified test procedure and/or details, the product shall show no physical damage and shall meet the electrical and mechanical requirements per paragraphs 6.0 and 7.0 as specified in the Table 1 test sequences. Unless specified otherwise, assemblies shall be mated during exposure.

- 9.1 <u>Thermal Shock</u> EIA 364-32, Test Condition VIII, No damage to parts
 - a. Number of Cycles 25
 - b. Temperature Range Between -40 and 105 °C
 - c. Time at Each Temperature 30 minutes
 - d. Transfer Time 5 minutes maximum
- 9.2 <u>Humidity/Temperature cycling</u> EIA-364-31 Method III (cyclic temperature)

Samples are to be subjected to 10 cycles of 10 hour duration for a total of 100 hours. No damage to parts. A cycle consists of the following steps:

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		a. 2 hour ramp from	25°C at 80%-98% RH to 65°C at 90%-98	% RH	
		b. 4 hour dwell at 65			
		c. 2 hour ramp down	to 25°C at 80%-98% RH		
		d. 2 hour dwell at 25	°C at 80%-98% RH		
ç	9.3	High Temperature Lif	e – EIA-364-17, Method A, Test Conditio	n 5.	
			emain fully assembled and mated withou		damage to
		a. Test Temperature	- 125±2°C		
		b. Test Duration - 50	0 hours		
ć	9.4	Vibration (Random) -	EIA 364-28, Test Condition VII, Conditio	n letter D.	
		a. Vibration Amplitud	le – 3.10 rms G minimum		
		b. Frequency range	20 to 500 Hz		
		b. Duration – 15 min	utes along each of three orthogonal axes		
		d. Mounting - Rigidly	mount assemblies.		
		e. No discontinuities	greater than 1 micro second.		
ę	9.5	Mechanical Shock - I	EIA 364-27, Condition H.		
		a. Condition - Half-S	ine 30G, 11 milli-second duration		
		b. Shocks - 3 shocks	in both directions along each of three or	thogonal axes.	
		c. Mounting - Rigidly	mount assemblies		
		d. No discontinuities	greater than 1 microsecond.		
10.0	QU	ALITY ASSURANCE	PROVISIONS		
	10.1	Equipment Calibration	n		
			d inspection facilities used in the performation accordance with ISO 9000.	ance of any test shall be	maintained in a
	10.2	Inspection Conditions	3		
		Unless otherwise spe	cified herein, all inspections shall be perf	ormed under the followin	g
		ambient conditions:			

- a. Temperature: 25 +/- 5 deg C
- b. Relative Humidity: 30% to 75%

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10.3 Sample Quantity and Description

Specimens shall be prepared in accordance with applicable instruction sheets and shall be selected at random from current production. Each test group shall consist of a minimum of 5 specimens soldered to FR-4 printed circuit boards.

Qualification inspection shall be verified by testing specimens as specified in Table 1.

10.4 Acceptance

Electrical and mechanical requirements placed on test samples as indicated in the sections of this specification shall be established from test data using appropriate statistical techniques or shall otherwise be customer specified, and all samples tested in accordance with this product specification shall meet the stated requirements.

Failures attributed to equipment, test setup, or operator error shall not disqualify the product. If product failure occurs, corrective action shall be taken and samples resubmitted for qualification.

10.5 Qualification Testing

Qualification testing shall be performed on sample units produced with equipment and procedures normally used in production. The test sequences shall be as shown in the qualification test table.

10.6 Re-Qualification Testing

If any of the following conditions occur, the responsible product engineer shall initiate requalification testing consisting of all applicable parts of the qualification test matrix.

- a. A significant design change is made to the existing product which impacts the product form, fit or function. Examples of significant changes shall include, but not be limited to, changes in the plating material composition or thickness, contact force, contact surface geometry, insulator design, contact base material, or contact lubrication requirements.
- b. A significant change is made to the manufacturing process which impacts the product form, fit or function.
- c. A significant event occurs during production or end use requiring corrective action to be taken relative to the product design or manufacturing process.

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10.7 Qualification Test Table

Table 1

		Test Gr	oup (a)	
Test or Examination	1	2	3	4
	1	Fest Seq	uence (b)
Initial examination of product	1	1	1	1
LLCR	3,7	2,7		
Insulation resistance			2,6	
Withstanding voltage			3,7	
Temperature rise vs current		3,8(c)		
Resistance to reflow soldering heat				2
Random vibration	5	6		
Mechanical shock	6			
Durability	4			
Mating force	2(d)			
Unmating force	8(e)			
Thermal shock			4	
Humidity/temperature cycling		4(f)	5(g)	
Temperature life		5		
Final examination of product	9	9	8	3

- a. See section 10.3.
- b. Numbers indicate sequence in which tests are performed.
- c. Five specimens shall be used for initial temperature rise, while the other 5 specimens will run through the entire test sequence.
- d. Mate 5 specimens.
- e. Unmate 5 specimens
- f. Mated specimens.
- g. Unmated specimens

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REVISION RECORD

Rev	Page	Description	EC#	Date
А	All	NEW DOCUMENT	N/A	08/11/2013
В	1	CURRENT RATING UPDATED BASED ON TEST RESULT	ELX-I-16283	14/11/2013
С	1,3,5,8	CURRENT RATING & PARAMETERS UPDATED FOR ALL POSITIONS / MATING UNMATING FORCE & MATING CYCLES UPDATED BASED ON POSITIONS	ELX-I-54217	10/01/2025
D	2,3,4	HEADINGS UPDATED	ELX-I-54437	27/01/2025